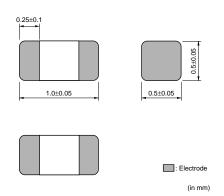
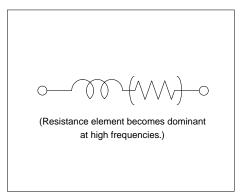
EMIFIL® (Inductor type) Chip Ferrite Bead

BLM15B Series (0402 Size)

■ Dimensions



■ Equivalent Circuit



■ Packaging

| Code | Packaging | Minimum Quantity | |
|------|------------------|------------------|--|
| D | 180mm Paper Tape | 10000 | |
| J | 330mm Paper Tape | 50000 | |
| В | Bulk(Bag) | 1000 | |

■ Rated Value (□: packaging code)

| Part Number | Impedance (at 100MHz/20°C) | Impedance (at 1GHz/20°C) | Rated Current | DC Resistance (max.) | Operating Temperature Range |
|----------------|-------------------------------|-----------------------------|---------------|----------------------|--------------------------------|
| BLM15BD750SN1□ | 75ohm±25% | - | 300mA | 0.20ohm | -55 to +125°C |
| BLM15BD121SN1□ | 120ohm±25% | - | 300mA | 0.30ohm | -55 to +125°C |
| BLM15BD221SN1□ | 220ohm±25% | - | 300mA | 0.40ohm | -55 to +125°C |
| BLM15BD471SN1□ | 470ohm±25% | - | 200mA | 0.60ohm | -55 to +125°C |
| BLM15BD601SN1□ | 600ohm±25% | - | 200mA | 0.65ohm | -55 to +125°C |
| BLM15BD102SN1□ | 1000ohm±25% | - | 200mA | 0.90ohm | -55 to +125°C |
| BLM15BD182SN1□ | 1800ohm±25% | - | 100mA | 1.40ohm | -55 to +125°C |
| BLM15BB050SN1□ | 5ohm±25% | - | 500mA | 0.08ohm | -55 to +125°C |
| BLM15BB100SN1□ | 10ohm±25% | - | 300mA | 0.10ohm | -55 to +125°C |
| BLM15BB220SN1□ | 22ohm±25% | - | 300mA | 0.20ohm | -55 to +125°C |
| BLM15BB470SN1□ | 47ohm±25% | - | 300mA | 0.35ohm | -55 to +125°C |
| BLM15BB750SN1□ | 75ohm±25% | - | 300mA | 0.40ohm | -55 to +125°C |
| BLM15BB121SN1□ | 120ohm±25% | - | 300mA | 0.55ohm | -55 to +125°C |
| BLM15BB221SN1□ | 220ohm±25% | - | 200mA | 0.80ohm | -55 to +125°C |
| BLM15BC121SN1□ | 120ohm±25% | - | 350mA | 0.45ohm | -55 to +125°C |
| BLM15BC241SN1□ | 240ohm±25% | - | 250mA | 0.70ohm | -55 to +125°C |
| BLM15BA050SN1□ | 5ohm±25% | - | 300mA | 0.10ohm | -55 to +125°C |
| BLM15BA100SN1□ | 10ohm±25% | - | 300mA | 0.20ohm | -55 to +125°C |

Number of Circuits: 1

Continued on the following page.

This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

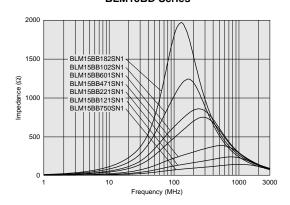
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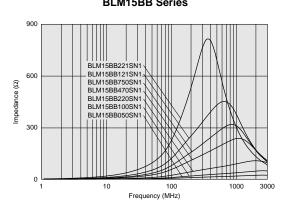
| Part Number | Impedance (at 100MHz/20°C) | Impedance (at 1GHz/20°C) | Rated Current | DC Resistance (max.) | Operating Temperature Range |
|----------------|-------------------------------|-----------------------------|---------------|----------------------|--------------------------------|
| BLM15BA220SN1□ | 22ohm±25% | - | 300mA | 0.30ohm | -55 to +125°C |
| BLM15BA330SN1□ | 33ohm±25% | - | 300mA | 0.40ohm | -55 to +125°C |
| BLM15BA470SN1□ | 47ohm±25% | - | 200mA | 0.60ohm | -55 to +125°C |
| BLM15BA750SN1□ | 75ohm±25% | - | 200mA | 0.80ohm | -55 to +125°C |

Number of Circuits: 1

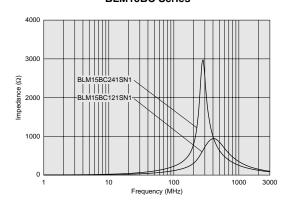
■ Impedance-Frequency Characteristics (Main Items) **BLM15BD Series**



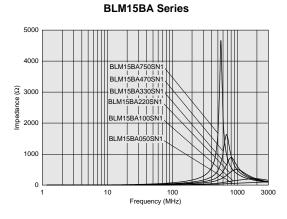
■ Impedance-Frequency Characteristics (Main Items) **BLM15BB Series**



■ Impedance-Frequency Characteristics (Main Items) **BLM15BC Series**



■ Impedance-Frequency Characteristics (Main Items)



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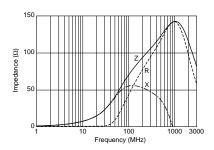
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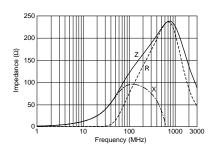
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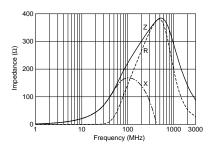
■ Impedance-Frequency Characteristics
BLM15BD750SN1



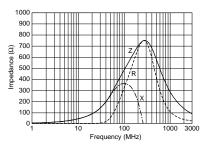
■ Impedance-Frequency Characteristics
BLM15BD121SN1



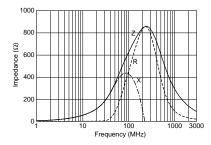
■ Impedance-Frequency Characteristics
BLM15BD221SN1



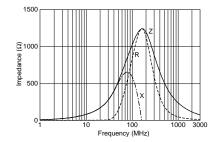
■ Impedance-Frequency Characteristics
BLM15BD471SN1



■ Impedance-Frequency Characteristics
BLM15BD601SN1



■ Impedance-Frequency Characteristics
BLM15BD102SN1



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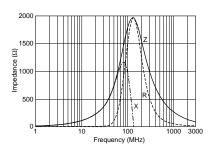
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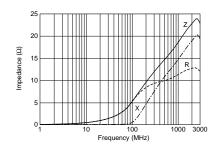
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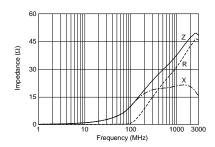
■ Impedance-Frequency Characteristics BLM15BD182SN1



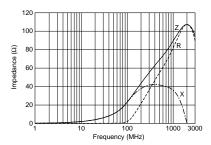
■ Impedance-Frequency Characteristics BLM15BB050SN1



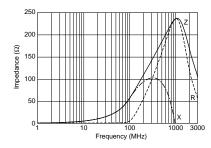
■ Impedance-Frequency Characteristics BLM15BB100SN1



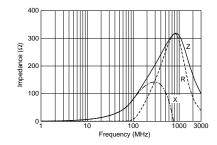
■ Impedance-Frequency Characteristics BLM15BB220SN1



■ Impedance-Frequency Characteristics BLM15BB470SN1



■ Impedance-Frequency Characteristics **BLM15BB750SN1**



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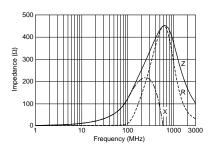
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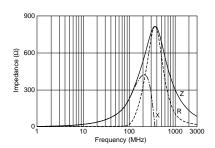
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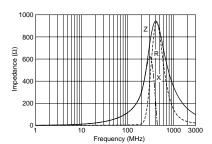
■ Impedance-Frequency Characteristics
BLM15BB121SN1



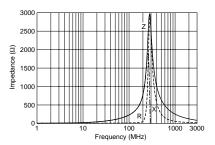
■ Impedance-Frequency Characteristics
BLM15BB221SN1



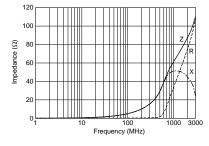
■ Impedance-Frequency Characteristics
BLM15BC121SN1



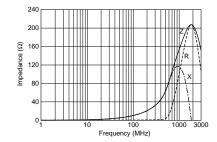
■ Impedance-Frequency Characteristics
BLM15BC241SN1



■ Impedance-Frequency Characteristics
BLM15BA050SN1



■ Impedance-Frequency Characteristics
BLM15BA100SN1



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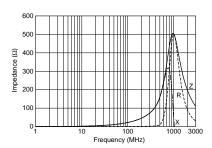
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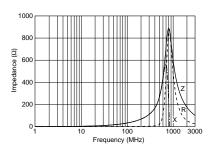
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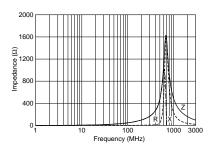
■ Impedance-Frequency Characteristics BLM15BA220SN1



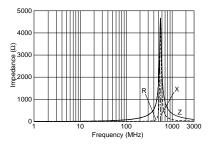
■ Impedance-Frequency Characteristics BLM15BA330SN1



■ Impedance-Frequency Characteristics BLM15BA470SN1



■ Impedance-Frequency Characteristics BLM15BA750SN1



■ ①Caution/Notice

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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